## : ©hipsmall

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With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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## Contact us

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## Delivery Specification

| Product Description | : Balun |
| :--- | :--- |
| Product Part Number | : EHF2BE1800 |
| Classification of Spec | : Individual Product Specification |
| Applications Cellular phone |  |
| For other applications, contact the undersigned in advance. |  |


| CUSTOMER USE ONLY | Receipt Record\#: |
| :--- | :--- |
| This was certainly received by us. <br> 1(one) copy is being returned to you. | Date of receipt: |
|  | Received by: |
|  | Title: <br>  Dept.: |

Matsushita Electronic Components Co., Ltd. Network Device Company
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Prepared by : H. Ito
Checked by : M. Mizuno
Authorized by : M. Mizuno
Title : Manager of Engineering
[Shape, appearance, dimension] Unit: mm <Top view>
<Bottom and side view>


Note 1) "typ" is used where no dimensional tolerance applies.

| Item | Description |
| :---: | :--- |
| Appearance/ <br> construction | Product surface shall be covered with a protective film, which does not <br> easily separate nor present noticeable unevenness, scratches, pinholes, <br> color changes etc. |
|  | Terminals shall ensure practically acceptable quality. |
|  | Substrate shall be as shown in the drawing with no excessive chippings, <br> scratches, burrs, or cracks. |
| Marking | Shall be legible in black (with printing paste). |
| Remarks | marked side for pin 1. |


| Balun | Delivery Specification |  |  |  | EHF2BE1800 <br> Appearance |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Enact. Date November 15, 2002 | $\begin{aligned} & \hline \text { P.S.M } \\ & \hline-----1 \end{aligned}$ | Approval <br> M. Mizuno | Check <br> M. Mizuno | Plan <br> H. Ito |  |  |
| Enfo. Date November 15, 2002 |  |  |  |  | $\begin{aligned} & \text { Drawing No. } \\ & \text { 151-EHF-2BE1800 } \end{aligned}$ | 9-1 |

[Absolute maximum ratings]

| No. | Item | Symbol | Rating | Unit | Remarks |
| :---: | :--- | :--- | :--- | :---: | :---: |
| 1 | Maximum input power | Pax | 100 | mW | DC voltage is 0V. |
| 2 | Operating temperature | Topr | $-30 \ldots+85$ | degC |  |
| 3 | Storage temperature | Tstg | $-40 \ldots+85$ | deg |  |

Note: This component cannot apply a DC Bias.
[Electrical characteristics]

$$
\mathrm{T}=-30 \ldots+85 \mathrm{deg} \mathrm{C}
$$

| No. | Item | Test | Specification |  |  | Unit |
| :---: | :--- | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| 1 | Frequency |  | 1700 | - | 1900 | MHz |
| 2 | Insertion loss (Back to back) | Fig-2 | - | - | 1.0 | dB |
| 3 | Unbalance impedance | - | - | 50 | - | ohm |
| 4 | Balance impedance | - | - | 100 | - | ohm |
| 5 | Unbalance port VSWR | Fig-1 | - | - | 2.0 | - |
| 6 | Amplitude balance | Fig-1 | -1.5 | - | 1.5 | dB |
| 7 | Phase balance | Fig-1 | 165 | 180 | 195 | deg |

[Internal circuitry]
(1) IN
(2)


[Measuring circuit]


FIG. 1

(3)OUT
 M $\perp$
<Phase balance measurement >
-Phat el
$\mathrm{A}=\mathrm{IN}, \mathrm{B}=\mathrm{OUT}, \mathrm{C}=$ Terminal resistor (50 ohm)
-Phase
$\mathrm{A}=\mathrm{IN}, \mathrm{C}=\mathrm{OUT}, \mathrm{B}=$ Terminal resistor (50 ohm)
-Phase balance
Phase balance=Phase1-Phase2
< Insertion loss measurement >
Assuming the loss as "Loss" when $\mathrm{D}=\mathrm{IN}, \mathrm{E}=\mathrm{OUT}$ Insertion loss for a device is "Loss"/2


[Terminal dimensions] Unit: mm
<Bottom>

(4)
(5)
(6)


Tolerance of
Terminal dimensions: +/-0.15
[Recommended PCB pad dimensions] Unit: mm


| Balun | Delivery Specification |  |  |  | EHF2BE1800 <br> Terminals/Recommended lands |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Enact. Date November 15, 2002 | $\begin{aligned} & \hline \text { P.S.M } \\ & \hline----- \end{aligned}$ | Approval <br> M. Mizuno | Check <br> M. Nizuno | $\begin{gathered} \text { Plan } \\ \text { H. Ito } \end{gathered}$ |  |  |
| Enfo. Date November 15, 2002 |  |  |  |  | $\begin{aligned} & \text { Drawing No. } \\ & \text { 151-EHF-2BE1800 } \end{aligned}$ | 9-3 |


[Cautions for use]
(1) Operating a product over the maximum rating for even a moment may result in a product failure or breakage. Never use a product in such a condition that it may cause a safety problem.
(2) Opening or short-circuiting the product terminals or inserting a product in the reverse orientation while power is being supplied may cause a breakage. Always avoid such circumstances.
(3) Operations in a corrosive gas atmosphere or improper environments such as hightemperature, high-humidity or dewy conditions may lead to product performance deterioration, a breakage, a change in appearance etc. Please avoid such conditions, as they are unsafe.
(4) Always ground the soldering iron or soldering bath used for assembly operation to avoid any excessive voltage applied to a product.
(5) After soldering with solder bridges, incomplete soldering or in the reverse orientation, supplying power may result in a product breakage. Please confirm the soldered condition before supplying power to the product.
(6) Excessive stress on the terminals may cause a contact failure or performance deterioration. Please use caution.
(7) Please provide a fail-safe provision in the product you design by taking any failure of our product into consideration.
(8) This product does not include a DC-cutting device. Application of a DC voltage between the Balance port and the Unbalance port may cause product deterioration or breakage.

* If any question arises about the safety of this product, please contact us immediately with a request for an engineering examination.
[Remarks]
*1: All of the materials used in this product are those listed as the existing chemical substances based on the "Law for examination and regulation of manufacture of chemical substances".
*2: The production process of this product does not use any ozonedepleting chemicals (OZC) regulated by the Montreal Protocol.
*3: Validity of this specification is 5 years from the date of issue, but the validity is considered on going unless any changes are made.

| Balun | Delivery Specification |  |  |  | EHF2BE1800 Cautions |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Enact. Date November 15, 2002 | P.S.M | Approval <br> M. Mizuno | $\begin{aligned} & \text { Check } \\ & \text { M. Mizuno } \end{aligned}$ | $\begin{aligned} & \text { Plan } \\ & \text { H. Ito } \end{aligned}$ |  |  |
| Enfo. Date November 15, 2002 | ----- |  |  |  | $\begin{aligned} & \text { Drawing No. } \\ & \text { 151-EHF-2BE1800 } \end{aligned}$ | 9-5 |

[Packaging materials]

1. Materials 1) Embossed carrier tape (Refer to the attachment)
2) Top tape: Anti-static
3) Packaging box (Refer to the attachment)
4) Packaging tape, carrier-securing adhesive tape
2. Specification

| No. | Item | Condition | Remarks |
| :---: | :---: | :---: | :---: |
| 1 | Reel outer diameter | Refer to the attachment. |  |
| 2 | Reel inner diameter | Refer to the attachment. |  |
| 3 | Reel inner width | Refer to the attachment. |  |
| 4 | Quantity in a reel | 4000 pieces/reel |  |
| 5 | Taping direction | Tape unreeling direction (with markings facing up) $\qquad$ |  |
| 6 | Top tape attachment position | carrier (Sprocket holes shall not be covered). | Tape breaks force. Min. 10 N Top cover tape strength. <br> Min. 10 N <br> Tape peel force. <br> 0.1...1.0N <br> Tape peel angle. <br> 165...180degree <br> Reel weight. <br> Max 1500 g |
| 7 | Label attachment position |  | Indicated Item Pat No., Lot No. Quantity, Maker Country of Origin |
| 8 | Tape leader part and tape ending part |  |  |
| 9 | Missing products | No missing products shall be allowed. |  |
| 10 | Packaged quantity in a box | 21 reels/box (Max) | 84000 pieces/box(Max) |


| Balun | Delivery Specification |  |  |  | EHF2BE1800 <br> Packaging specification 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Enact. Date November 15, 2002 | $\begin{aligned} & \text { P.S.M } \\ & \text {------ } \end{aligned}$ | Approval <br> M. Mizuno | Check <br> M. Mizuno | $\begin{gathered} \text { Plan } \\ \text { H. Ito } \end{gathered}$ |  |  |
| Enfo. Date November 15, 2002 |  |  |  |  | $\begin{aligned} & \text { Drawing No. } \\ & \text { 151-EHF-2BE1800 } \end{aligned}$ | 9-6 |

## 1. Method

1) Load products in each cavity of an embossed carrier tape, in the correct orientation, by leaving the product-unloaded part shown in Item No. 8(P9-6) of the packaging specification.
2) Heat-seal a top tape in good alignment on the carrier tape.
3) After 4000 pieces are loaded and reeled, provide a product-unloaded part at the tape-leader portion. Secure the tip of the carrier tape with a piece of adhesive tape.
4) Stack the reels (21 reels max.) and enclose them in a packaging box. Close the flaps with a piece of adhesive tape.
5) Provide markings on the packaging box.
< Items to be indicated >
1. Part No.
2. Quantity
3. Lot No.
4. Manufacturer name
5. Country of origin

Marking on the packaging box

[Embossed tape dimensions] Unit: mm

<Remarks>
(1) Unspecified corner radius shall be 0.3 mm max.
(2) Cumulative pitch error of sprocket holes shall be $+/-0.2 \mathrm{~mm}$ for 10 pitches.

| Balun | Delivery Specification |  |  |  | EHF2BE1800 <br> Packaging specification 3 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Enact. Date November 15, 2002 | $\begin{gathered} \text { P.S.M } \\ \hline-.---1 \end{gathered}$ | Approval <br> M. Mizuno | Check <br> M. Mizuno | Plan <br> H. Ito |  |  |
| Enfo. Date November 15, 2002 |  |  |  |  | $\begin{aligned} & \text { Drawing No. } \\ & \text { 151-EHF-2BE1800 } \end{aligned}$ | $9-8$ |



